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- Choice of Open-Collector, Open-Emitter, or **Totem-Pole Outputs**
- Single-Ended or Differential AND/NAND Outputs
- Single 5-V Supply
- **Dual-Channel Operation**
- **TTL Compatible**
- **Short-Circuit Protection**
- **High-Current Outputs**
- **Triple inputs**
- **Clamp Diodes at Inputs and Outputs**
- Designed for Use With SN55115 and SN75115 Differential Line Receivers
- Designed to Be Interchangeable With National DS9614 Line Driver

description

The SN55114 and SN75114 dual differential line drivers are designed to provide differential output signals with the high-current capability for driving balanced lines, such as twisted pair, at normal line impedances without high power dissipation. The output stages are similar to TTL totem-pole outputs, but with the sink outputs, YS and ZS, and the corresponding active pullup terminals, YP and ZP, available on adjacent package pins. Since the output stages provide TTL-compatible output levels, these devices can also be used as TTL expanders or phase splitters.

	D OR	N PACK					
SN75114 D OR N PACKAGE (TOP VIEW) 1ZP 1 16 V _{CC} 1ZS 2 15 2ZP 1YS 3 14 2ZS 1YP 4 13 2YS 1A 5 12 2YP 1B 6 11 2C 1C 7 10 2B GND 8 9 2A SN55114 FK PACKAGE (TOP VIEW)							
			ЭE				
1YS 4 1YP 5		20 19 18 17	Ξ				
		16					

zs 1 1 ΥS С 2YP 1A 🛛 7 15 2C 1B 9 10 11 12 13 2A 2B

NC - No internal connection

The SN55114 is characterized for operation over the full military temperature range of -55°C to 125°C. The SN75114 is characterized for operation from 0°C to 70°C.

FUNCTION TABLE									
INPUTS			OUT	PUTS					
А	В	С	Y	Z					
Н	Н	Н	Н	L					
All other	input comb	oinations	L	Н					

H = high level, L = low level



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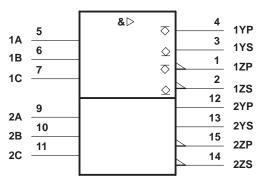
PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.



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logic symbol[†]

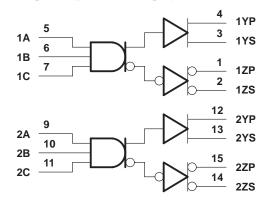


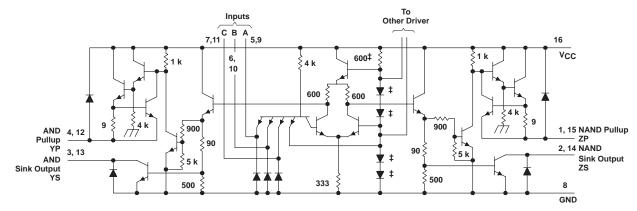
[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

Pin numbers shown are for the D, J, N, and W packages.

schematic (each driver)

logic diagram (positive logic)





[‡] These components are common to both drivers. Resistor values shown are nominal and in ohms. Pin numbers shown are for the D, J, N, and W packages.



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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

Supply voltage, V _{CC} (see Note 1)	
Input voltage, V _I	5.5 V
Off-state voltage applied to open-collector outputs	12 V
Continuous total power dissipation	See Dissipation Rating Table
Storage temperature range, T _{stg}	65°C to 150°C
Case temperature for 60 seconds, T _c : FK package	260°C
Lead temperature 1,6 mm (1/16 inch) from case for 60 seconds: J or W packa Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds: D or N packa	

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. All voltage values are with respect to the network ground terminal.

	Ы	SSILATION RATING TAL		-
PACKAGE	$T_A \le 25^{\circ}C$ POWER RATING	DERATING FACTOR ABOVE T _A = 25°C	T _A = 70°C POWER RATING	T _A = 125°C POWER RATING
D	950 mW	7.6 mW/°C	608 mW	—
fK‡	1375 mW	11.0 mW/°C	880 mW	275 mW
‡ر	1375 mW	11.0 mW/°C	880 mW	275 mW
Ν	1150 mW	9.2 mW/°C	736 mW	_
w‡	1000 mW	8.0 mW/°C	640 mW	200 mW

DISSIPATION RATING TABLE

[‡] In the FK, J, and W packages, SN55114 chips are either silver glass or alloy mounted.

recommended operating conditions (unless otherwise noted)

	SN55114			SN75114			UNIT
	MIN	NOM	MAX	MIN	NOM	MAX	UNIT
Supply voltage, V _{CC}	4.5	5	5.5	4.75	5	5.25	V
High-level input voltage, V _{IH}	2			2			V
Low-level input voltage, VIL			0.8			0.8	V
High-level output current, IOH			-40			-40	mA
Low-level output current, IOL			40			40	mA
Operating free-air temperature, TA	-55		125	0		70	°C



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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

					SN55114			SN75114			
	PARAMETER	T T	TEST CONDITIONS [†]		MIN TYP [‡] MAX		MAX	MIN	/IN TYP [‡] MAX		UNIT
VIK	Input clamp voltage	$V_{CC} = MIN,$	lj = – 12 mA	_		-0.9	-1.5		-0.9	-1.5	V
Val	High-level output	V _{CC} = MIN,	V _{IH} = 2 V,	I _{OH} = -10 mA	2.4	3.4		2.4	3.4		V
VOH	voltage	VIL = 0.8 V		$I_{OH} = -40 \text{ mA}$	2	3		2	3		v
V _{OL}	Low-level output voltage	$V_{CC} = MIN,$ $V_{IL} = 0.8 V,$	V _{IH} = 2 V, I _{OL} = 40 mA			0.2	0.4		0.2	0.45	V
Varia		V _{CC} = 5 V,	I _O = 40 mA,	$T_A = 25^{\circ}C$		6.1	6.5		6.1	6.5	v
VOK	Output clamp voltage	$V_{CC} = MAX,$	$I_{O} = -40 \text{ mA},$	$T_A = 25^{\circ}C$		-1.1	-1.5		-1.1	-1.5	V
	Off-state open collector output current	V _{CC} = MAX	V _{OH} = 12 V	$T_A = 25^{\circ}C$		1	100				μΑ
				T _A = 125°C			200				
IO(off)			V _{OH} = 5.25 V	$T_A = 25^{\circ}C$					1	100	
				$T_A = 70^{\circ}C$						200	
tı	Input current at maximum input voltage	V _{CC} = MAX,	V _I = 5.5 V				1			1	mA
Iн	High-level input current	$V_{CC} = MAX,$	VI = 2.4 V				40			40	μΑ
Ι _Ι	Low-level input current	V _{CC} = MAX,	V _I = 0.4 V			-1.1	-1.6		-1.1	-1.6	mA
IOS	Short-circuit output current§	V _{CC} = MAX,	V _O = 0,	$T_A = 25^{\circ}C$	-40	-90	-120	-40	-90	-120	mA
100	Supply current	All inputs at 0	V, No load,	V _{CC} = MAX		37	50		37	50	mA
ICC	(both drivers)	T _A = 25°C		$V_{CC} = 7 V$		47	65		47	70	IIIA

[†] All parameters, with the exception of off-state open-collector output current, are measured with the active pullup connected to the sink output. For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

[‡] All typical values are at $T_A = 25^{\circ}C$ and $V_{CC} = 5$ V, with the exception of I_{CC} at 7 V.

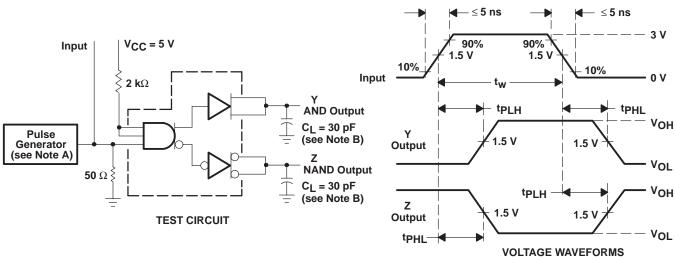
§ Only one output should be shorted at a time, and duration of the short circuit should not exceed one second.

switching characteristics, V_{CC} = 5 V, T_A = 25°C

PARAMETER		TEST	SN55114			SN75114			UNIT
	FARAMETER	CONDITIONS	MIN	TYP	MAX	MIN	TYP	MAX	UNIT
^t PLH	Propagation delay time, low- to high-level output	C _L = 30 pF,		15	20		15	30	ns
^t PHL	Propagation delay time, high- to low-level output	See Figure 1		11	20		11	30	ns



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PARAMETER MEASUREMENT INFORMATION

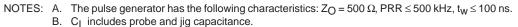
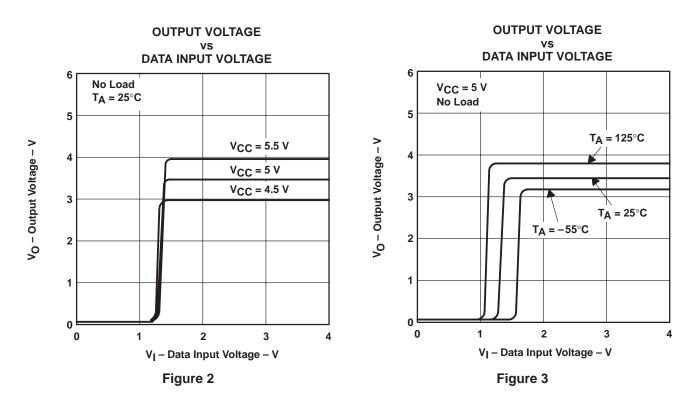


Figure 1. Test Circuit and Voltage Waveforms

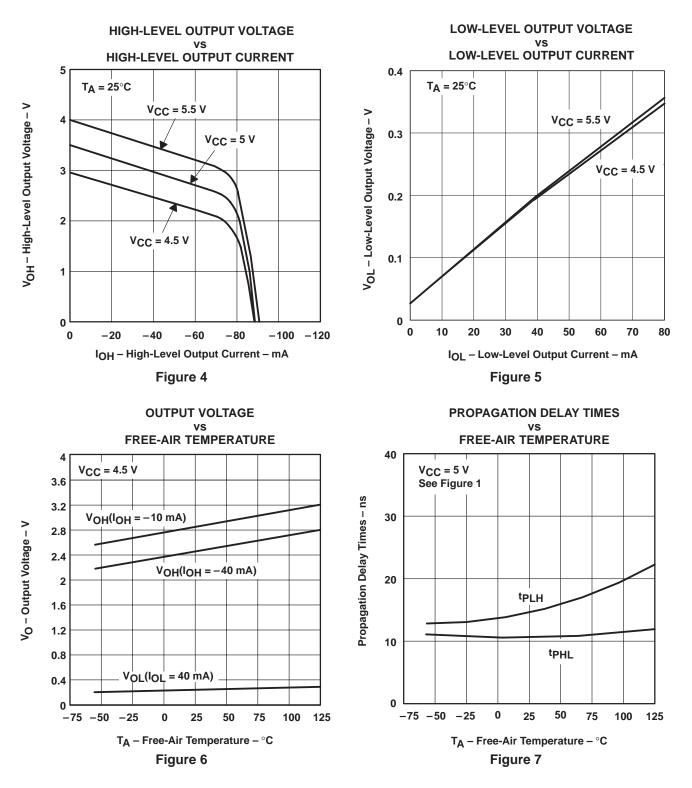


TYPICAL CHARACTERISTICS[†]

[†] Operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. These parameters were measured with the active pullup connected to the sink output.



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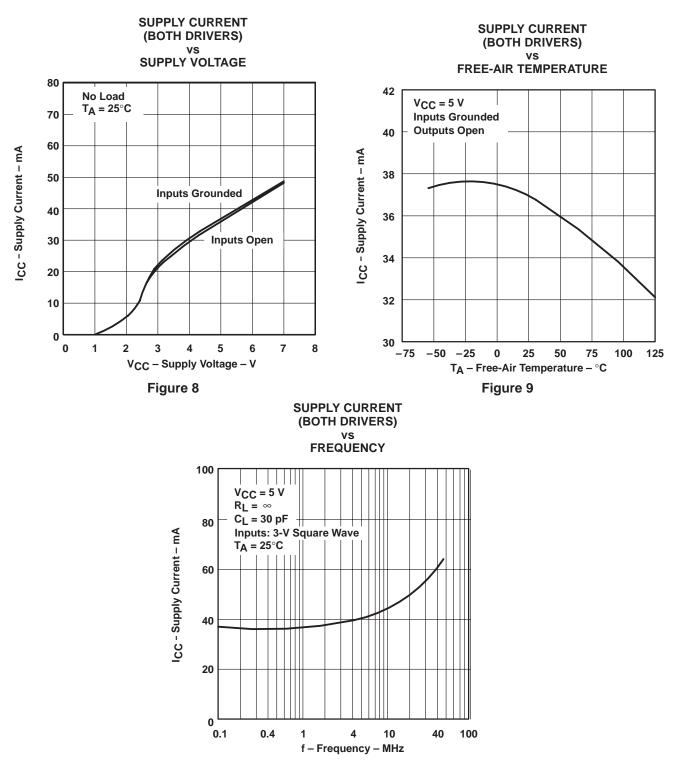


TYPICAL CHARACTERISTICS[†]

[†] Operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. These parameters were measured with the active pullup connected to the sink output.



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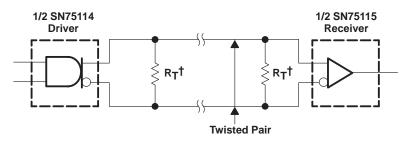
TYPICAL CHARACTERISTICS[†]

Figure 10

[†] Operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. These parameters were measured with the active pullup connected to the sink output.

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APPLICATION INFORMATION



 † R_T = Z_O. A capacitor can be connected in series with R_T to reduce power dissipation.

Figure 11. Basic Party-Line or Data-Bus Differential Data Transmission



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